### End of Life January-2025 - Alternative Device: TSHG6400



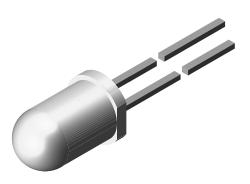
DESCRIPTION

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**Vishay Semiconductors** 

**TSHG8400** 

# High Speed Infrared Emitting Diode, 830 nm, GaAlAs Double Hetero



TSHG8400 is an infrared, 830 nm emitting diode in GaAlAs

double hetero (DH) technology with high radiant power and

high speed, molded in a clear, untinted plastic package.

### FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm): Ø 5
- Peak wavelength:  $\lambda_p = 830 \text{ nm}$
- High reliability
- · High radiant power
- · High radiant intensity
- Angle of half intensity:  $\varphi = \pm 22^{\circ}$
- · Low forward voltage
- · Suitable for high pulse current operation
- High modulation bandwidth:  $f_c = 18$  MHz
- Good spectral matching with CMOS cameras
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Infrared radiation source for operation with CMOS cameras (illumination)
- High speed IR data transmission

| PRODUCT SUMMARY |                        |       |                     |                     |  |
|-----------------|------------------------|-------|---------------------|---------------------|--|
| COMPONENT       | l <sub>e</sub> (mW/sr) | φ (°) | λ <sub>p</sub> (nm) | t <sub>r</sub> (ns) |  |
| TSHG8400        | 70                     | ± 22  | 830                 | 20                  |  |

#### Note

Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION |           |                              |              |  |  |
|----------------------|-----------|------------------------------|--------------|--|--|
| ORDERING CODE        | PACKAGING | REMARKS                      | PACKAGE FORM |  |  |
| TSHG8400             | Bulk      | MOQ: 4000 pcs, 4000 pcs/bulk | T-1¾         |  |  |

Note

• MOQ: minimum order quantity

| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25 \text{ °C}$ , unless otherwise specified) |  |                   |             |      |  |
|---|--|-------------------|-------------|------|--|
| PARAMETER   | TEST CONDITION                           | SYMBOL            | VALUE       | UNIT |  |
| Reverse voltage   |  | V <sub>R</sub>    | 5           | V    |  |
| Forward current   |  | l <sub>F</sub>    | 100         | mA   |  |
| Peak forward current  | $t_p/T = 0.5, t_p = 100 \ \mu s$         | I <sub>FM</sub>   | 200         | mA   |  |
| Surge forward current   | t <sub>p</sub> = 100 μs                  | I <sub>FSM</sub>  | 1           | А    |  |
| Power dissipation   |  | Pv                | 180         | mW   |  |
| Junction temperature  |  | Tj                | 100         | °C   |  |
| Operating temperature range   |  | T <sub>amb</sub>  | -40 to +85  | °C   |  |
| Storage temperature range   |  | T <sub>stg</sub>  | -40 to +100 | °C   |  |
| Soldering temperature   | $t \le 5$ s, 2 mm from case              | T <sub>sd</sub>   | 260         | °C   |  |
| Thermal resistance junction to ambient  | J-STD-051,<br>leads 7 mm soldered on PCB | R <sub>thJA</sub> | 230         | K/W  |  |

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1 For technical questions, contact: <u>emittertechsupport@vishay.com</u> Document Number: 81297



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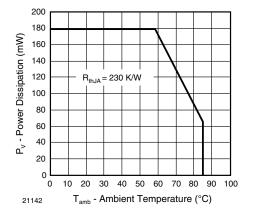
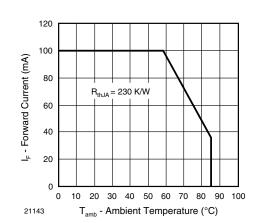


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature



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Fig. 2 - Forward Current Limit vs. Ambient Temperature

| <b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |   |                  |      |       |      |       |
|---|---|------------------|------|-------|------|-------|
| PARAMETER   | TEST CONDITION                                      | SYMBOL           | MIN. | TYP.  | MAX. | UNIT  |
| Forward voltage   | I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms     | V <sub>F</sub>   | -    | 1.5   | 1.8  | V     |
|   | $I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$       | V <sub>F</sub>   | -    | 2.3   | -    | V     |
| Temperature coefficient of V <sub>F</sub>   | I <sub>F</sub> = 1 mA                               | TK <sub>VF</sub> | -    | -1.8  | -    | mV/K  |
| Reverse current   | $V_R = 5 V$   | I <sub>R</sub>   | -    |       | 10   | μA    |
| Junction capacitance  | V <sub>R</sub> = 0 V, f = 1 MHz, E = 0              | Cj               | -    | 125   | -    | pF    |
| Radiant intensity   | $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms           | l <sub>e</sub>   | 45   | 70    | 135  | mW/sr |
|   | $I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$       | l <sub>e</sub>   | -    | 700   | -    | mW/sr |
| Radiant power   | I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms     | φ <sub>e</sub>   | -    | 50    | -    | mW    |
| Temperature coefficient of $\phi_{e}$   | I <sub>F</sub> = 100 mA                             | TKφe             | -    | -0.35 | -    | %/K   |
| Angle of half intensity   |   | φ                | -    | ± 22  | -    | 0     |
| Peak wavelength   | I <sub>F</sub> = 100 mA                             | λρ               | -    | 830   | -    | nm    |
| Spectral bandwidth  | I <sub>F</sub> = 100 mA                             | Δλ               | -    | 40    | -    | nm    |
| Temperature coefficient of $\lambda_p$  | I <sub>F</sub> = 100 mA                             | ΤΚλρ             | -    | 0.25  | -    | nm/K  |
| Rise time   | I <sub>F</sub> = 100 mA                             | t <sub>r</sub>   | -    | 20    | -    | ns    |
| Fall time   | I <sub>F</sub> = 100 mA                             | t <sub>f</sub>   | -    | 13    | -    | ns    |
| Cut-off frequency   | $I_{DC} = 70 \text{ mA}, I_{AC} = 30 \text{ mA pp}$ | f <sub>c</sub>   | -    | 18    | -    | MHz   |
| Virtual source diameter   |   | d                | -    | 3.7   | -    | mm    |

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#### BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

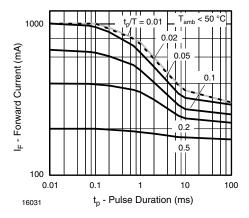


Fig. 3 - Pulse Forward Current vs. Pulse Duration

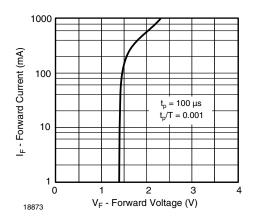


Fig. 4 - Forward Current vs. Forward Voltage

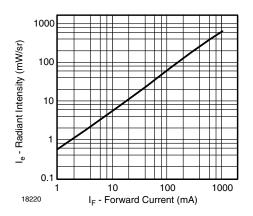


Fig. 5 - Radiant Intensity vs. Forward Current

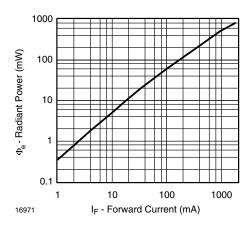


Fig. 6 - Radiant Power vs. Forward Current

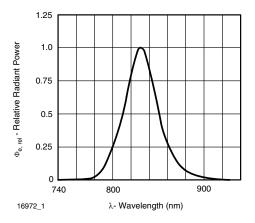


Fig. 7 - Relative Radiant Power vs. Wavelength

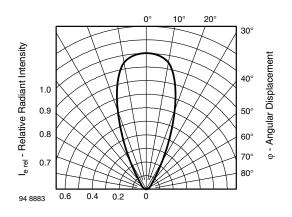


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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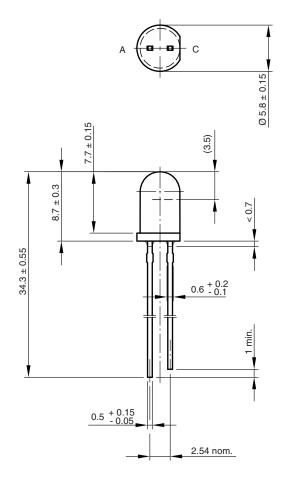


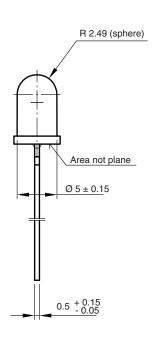
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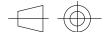
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#### **PACKAGE DIMENSIONS** in millimeters







technical drawings according to DIN specifications

Drawing-No.: 6.544-5259.06-4 Issue: 6; 19.05.09 19257

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